



SM12

DUAL COMMON ANODE TVS DIODE

Features

- 300 Watts Peak Pulse Power (tp = 8x20μs)
- IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Typically Used at Computer Interface Protection, Data Line and Power Line Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

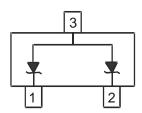
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 63
- Weight: 0.0089 grams (approximate)





Top View



Device Schematic

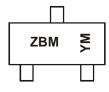
Ordering Information (Note 4)

Part Number	Case	Packaging
SM12-7	SOT23	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



ZBM = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Year	201	2	2013		2014	20	15	2016		2017	1	2018
Code	Z		Α		В	(2	D		E		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = 25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_{PP}	300	V	8/20µs, Per Fig. 3
Peak Pulse Current	I _{PP}	12	Α	8/20µs, Per Fig. 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2(ESD)
ESD Protection – Air Discharge	V_{ESD_Air}	±15	kV	Standard IEC 61000-4-2(ESD)
Electrical Fast Transient Current	I _{EFT}	40	Α	Standard IEC 61000-4-4(EFT)

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T_{J} , T_{STG}	-65 to +150	°C

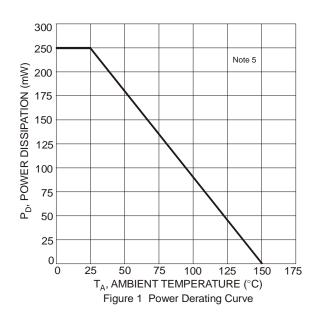
Electrical Characteristics (@T_A = 25°C unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	VRWM	-	-	12.0	V	-
Reverse Current (Note 6)	IR	-	-	1.0	μA	$V_R = V_{RWM} = 12.0V$
Reverse Breakdown Voltage	V _{BR}	13.3	-	15.75	V	I _R = 1mA
Reverse Clamping Voltage	V_{CL}	-	-	19	V	$I_{PP} = 1A$, $t_p = 8/20 \mu s$
Capacitance	CT	1	95	-	pF	$V_R = 0V$, $f = 1MHz$, Pin 1 to 3

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

 6. Short duration pulse test used to minimize self-heating effect.



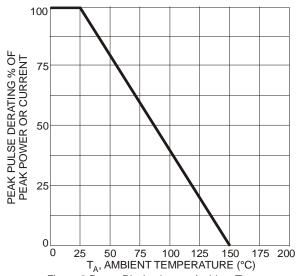
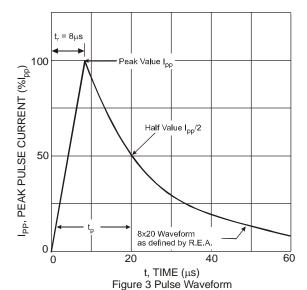
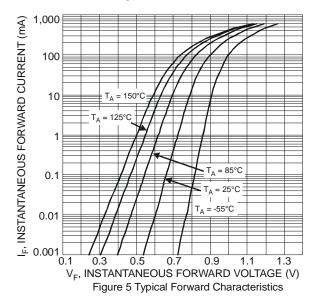


Figure 2 Power Dissipation vs. Ambient Temperature







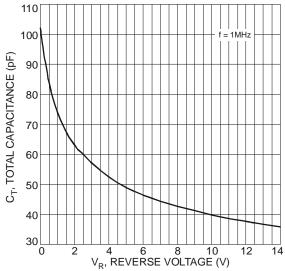


Figure 7 Typical Total Capacitance vs. Reverse Voltage

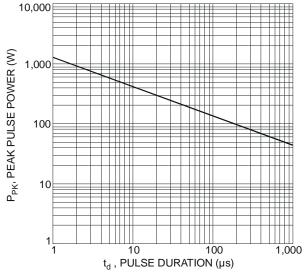
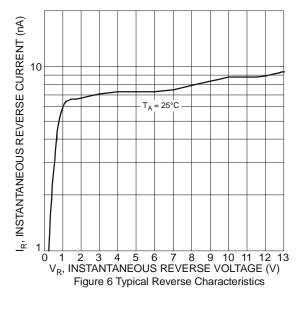


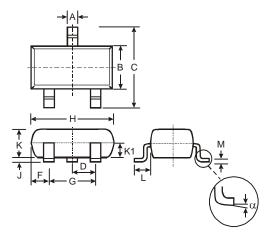
Figure 4 Max. Peak Pulse Power vs. Pulse Duration





Package Outline Dimensions

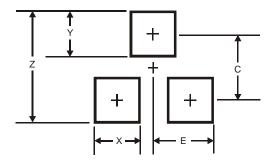
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
C	2.0
E	1.35



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